



US009448590B2

(12) **United States Patent**
Hirai et al.

(10) **Patent No.:** **US 9,448,590 B2**
(45) **Date of Patent:** **Sep. 20, 2016**

- (54) **ELECTRONIC APPARATUS** 2005/0117286 A1* 6/2005 Karashima G06F 1/1616
361/679.28
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361/679.33
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2015/0103493 A1* 4/2015 Hirai G06F 1/1633
361/728

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- (*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 249 days.

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(21) Appl. No.: **14/330,792**

(22) Filed: **Jul. 14, 2014**

Primary Examiner — Anthony Q Edwards

(65) **Prior Publication Data**
US 2015/0103493 A1 Apr. 16, 2015

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Related U.S. Application Data

(60) Provisional application No. 61/891,835, filed on Oct. 16, 2013.

(57) **ABSTRACT**

- (51) **Int. Cl.**
G06F 1/16 (2006.01)
- (52) **U.S. Cl.**
CPC **G06F 1/1633** (2013.01)
- (58) **Field of Classification Search**
None
See application file for complete search history.

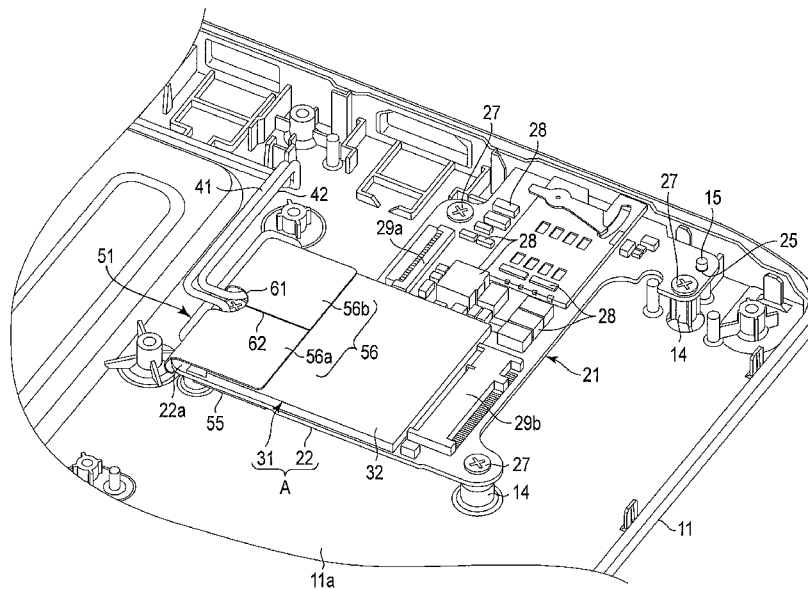
According to one embodiment, an apparatus includes a board, a module, cables, and an insulator. The module includes a module body having a first end portion protruding to form a step and module terminals attached to the first end portion. The first end portion is thinner than a main portion of the module body. The protrusion height of the module terminal is less than that of the step. The cables have cable terminals fixed to the module terminals. The insulator has a first adhesive portion adhered to an adhesive point arranged on the back side to the first surface opposite to the board, a second adhesive portion adhered to the first surface, and a cover portion continued to the second adhesive portion and covering the cable terminal between both adhesive portions.

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14 Claims, 13 Drawing Sheets



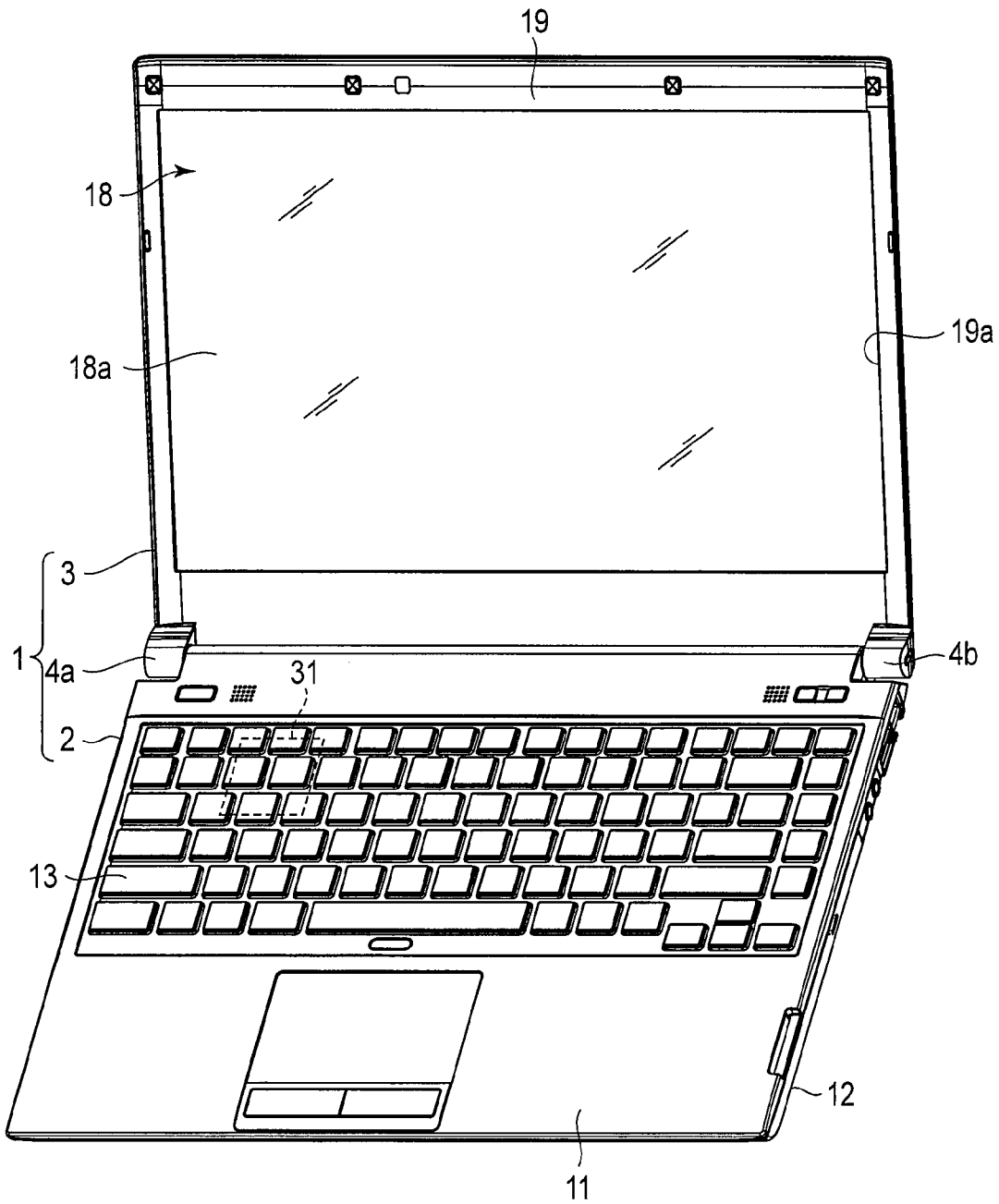


FIG. 1

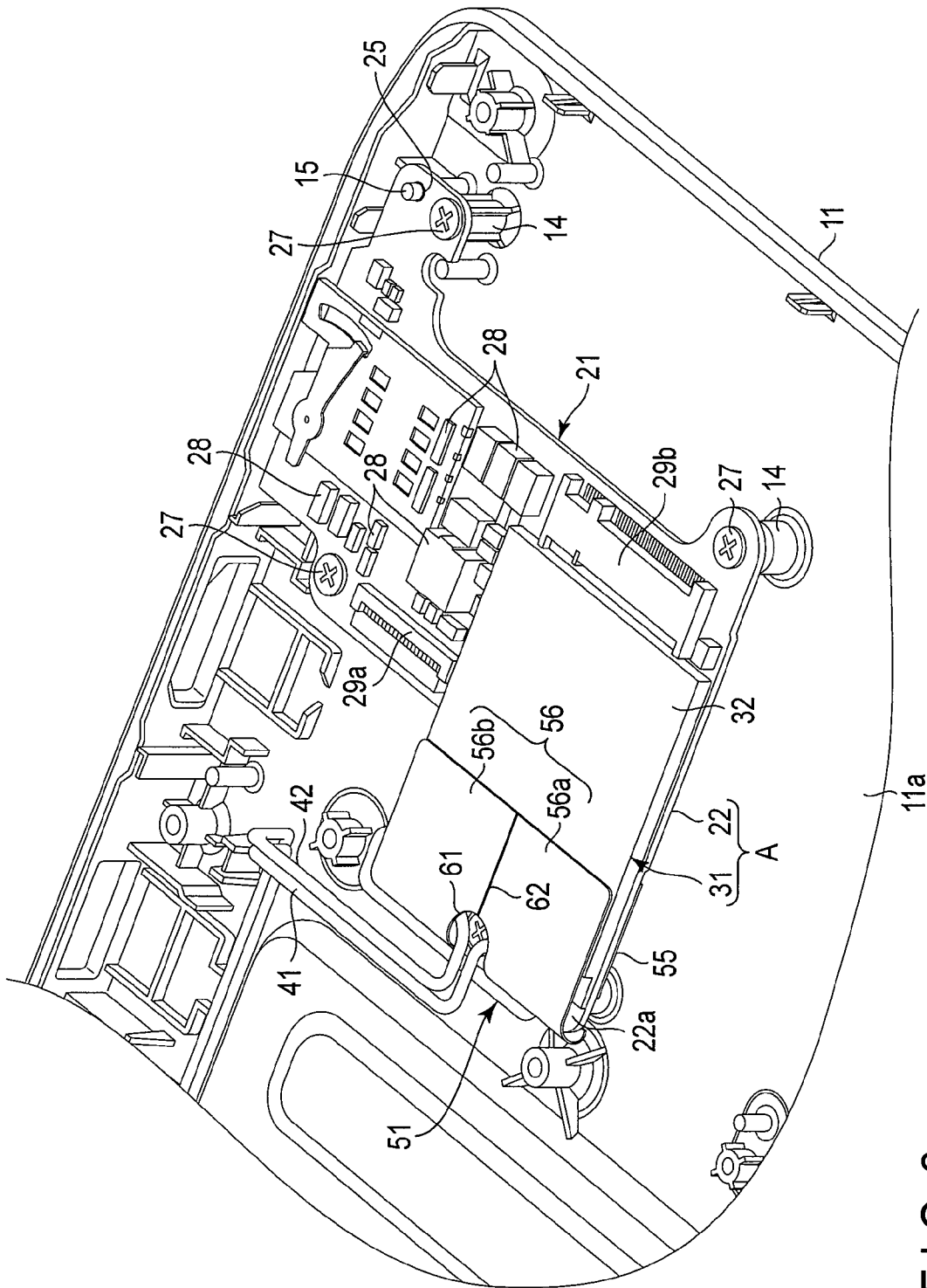


FIG. 2

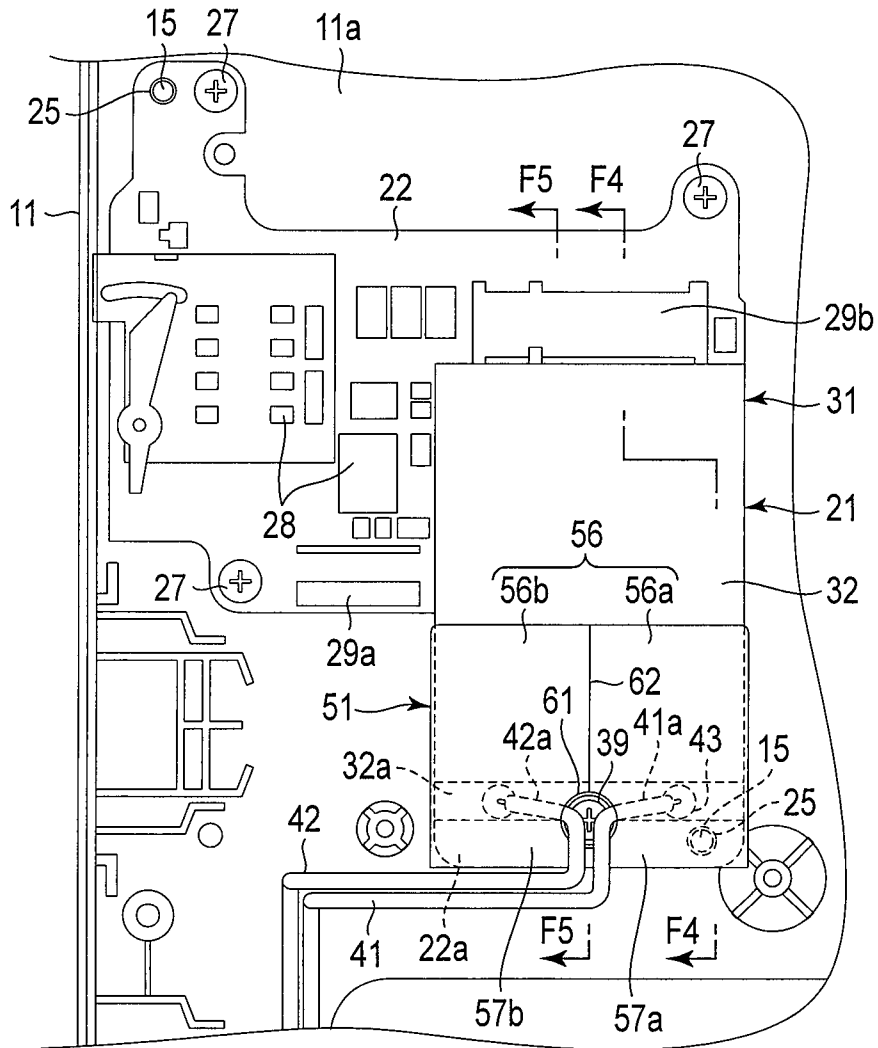


FIG. 3

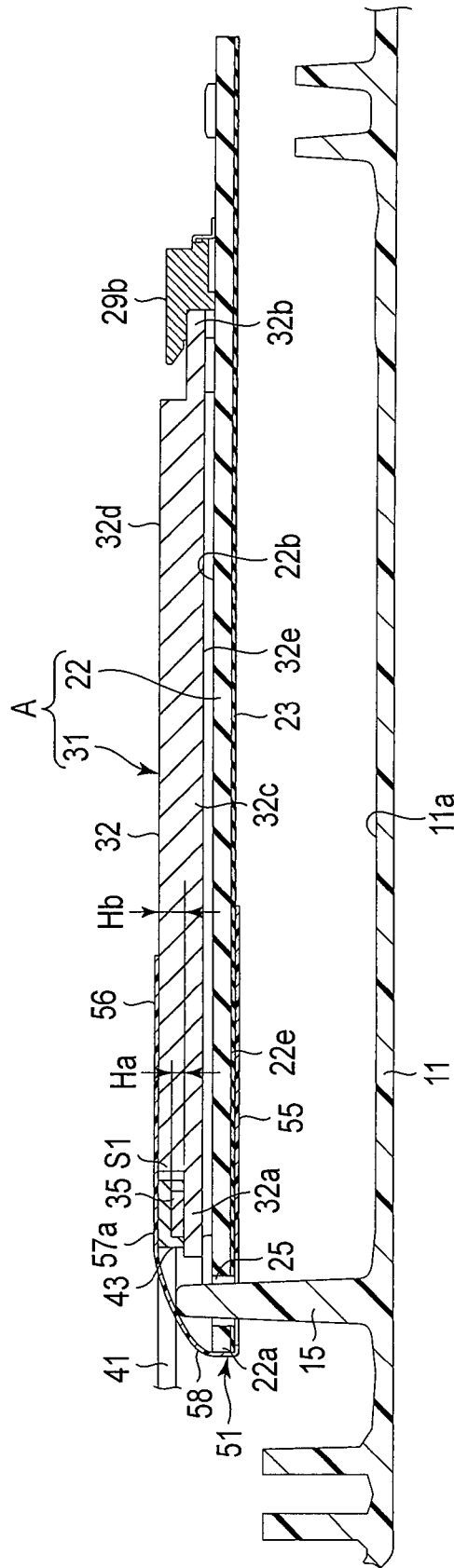


FIG. 4

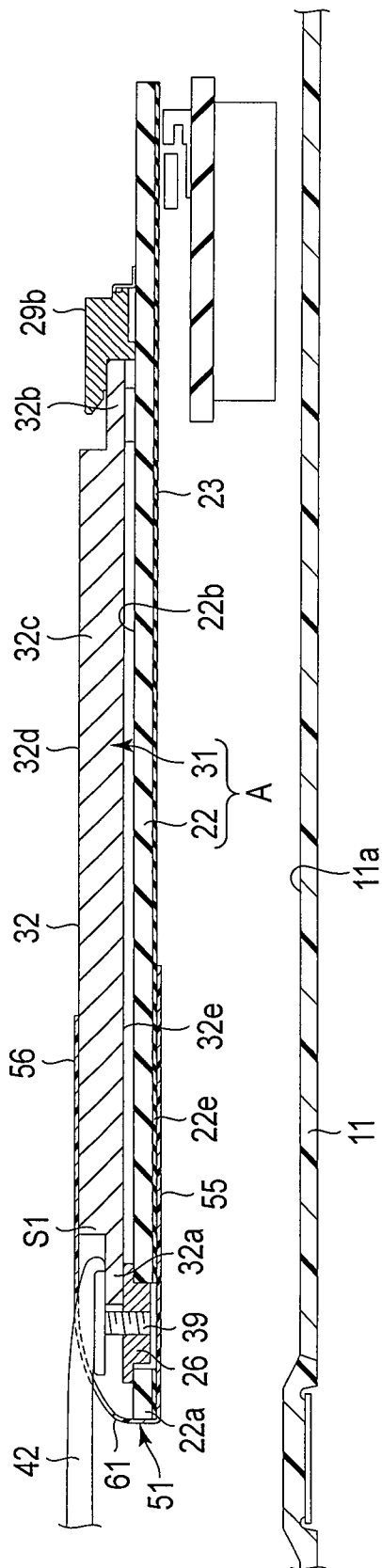


FIG. 5

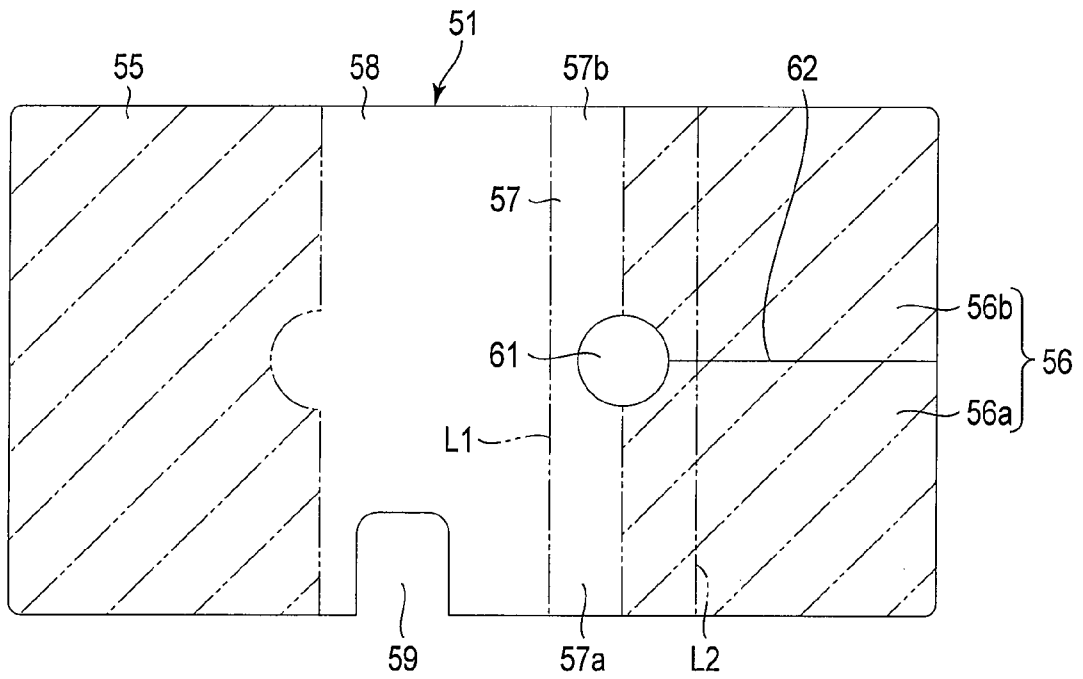


FIG. 6

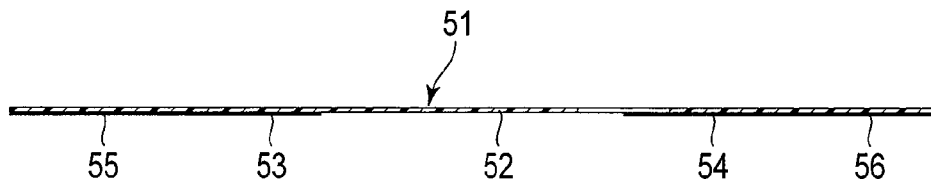


FIG. 7

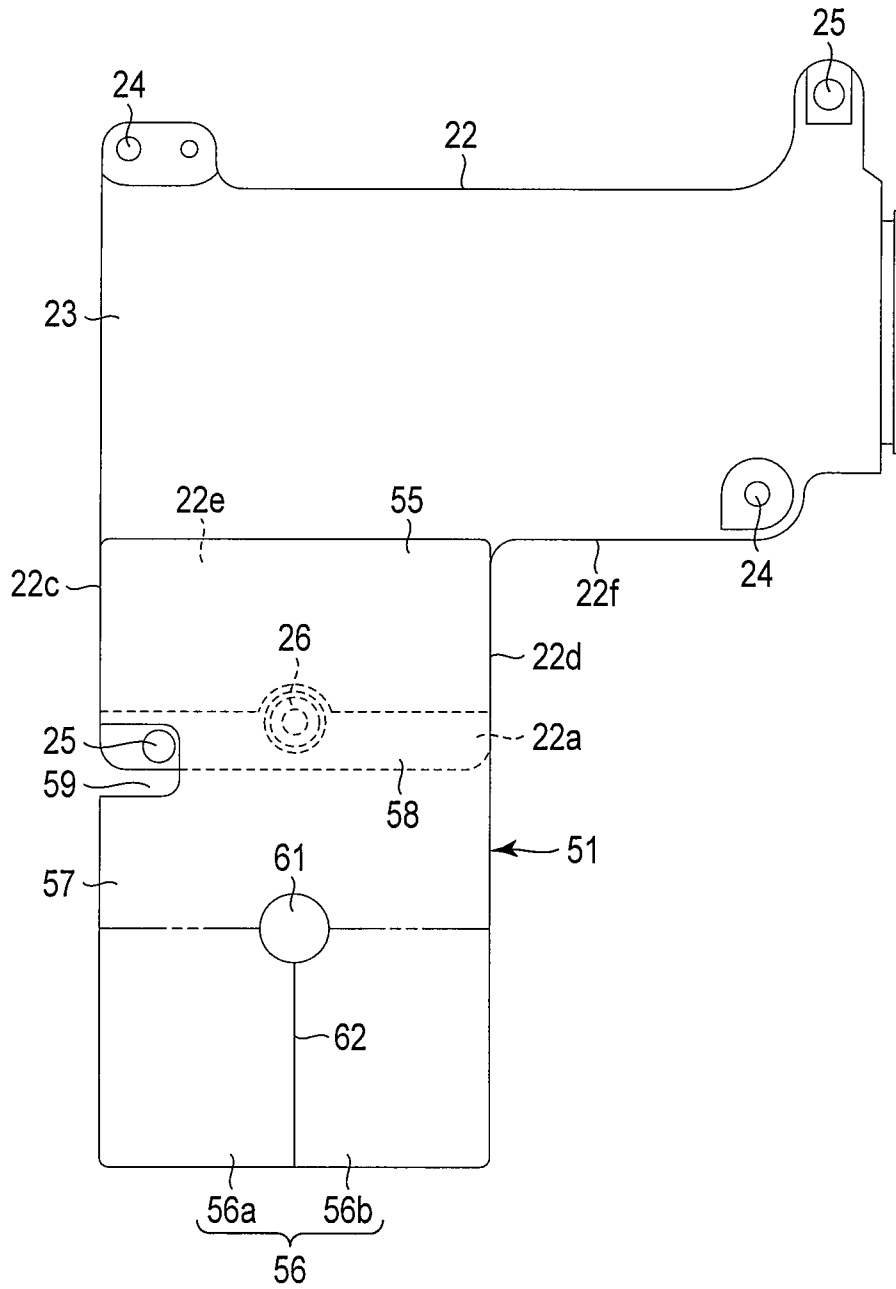


FIG. 8

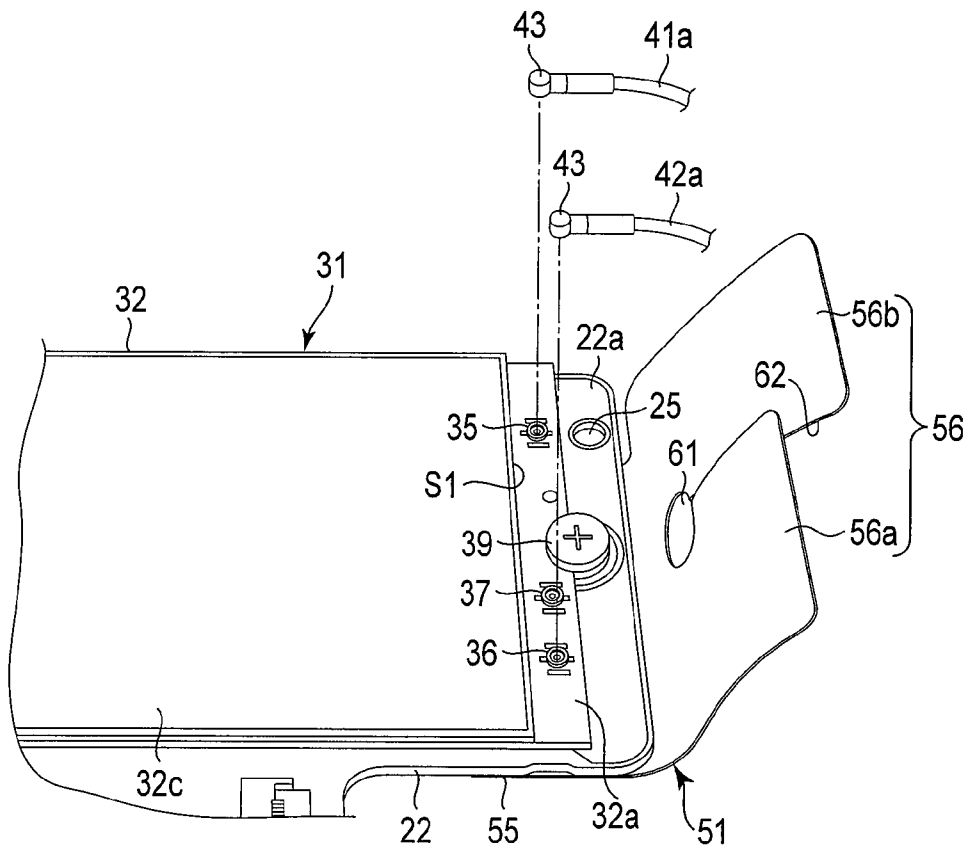


FIG. 9

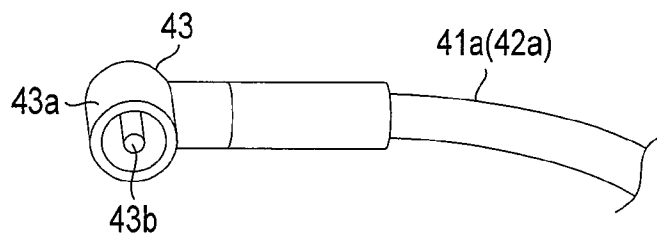


FIG. 10

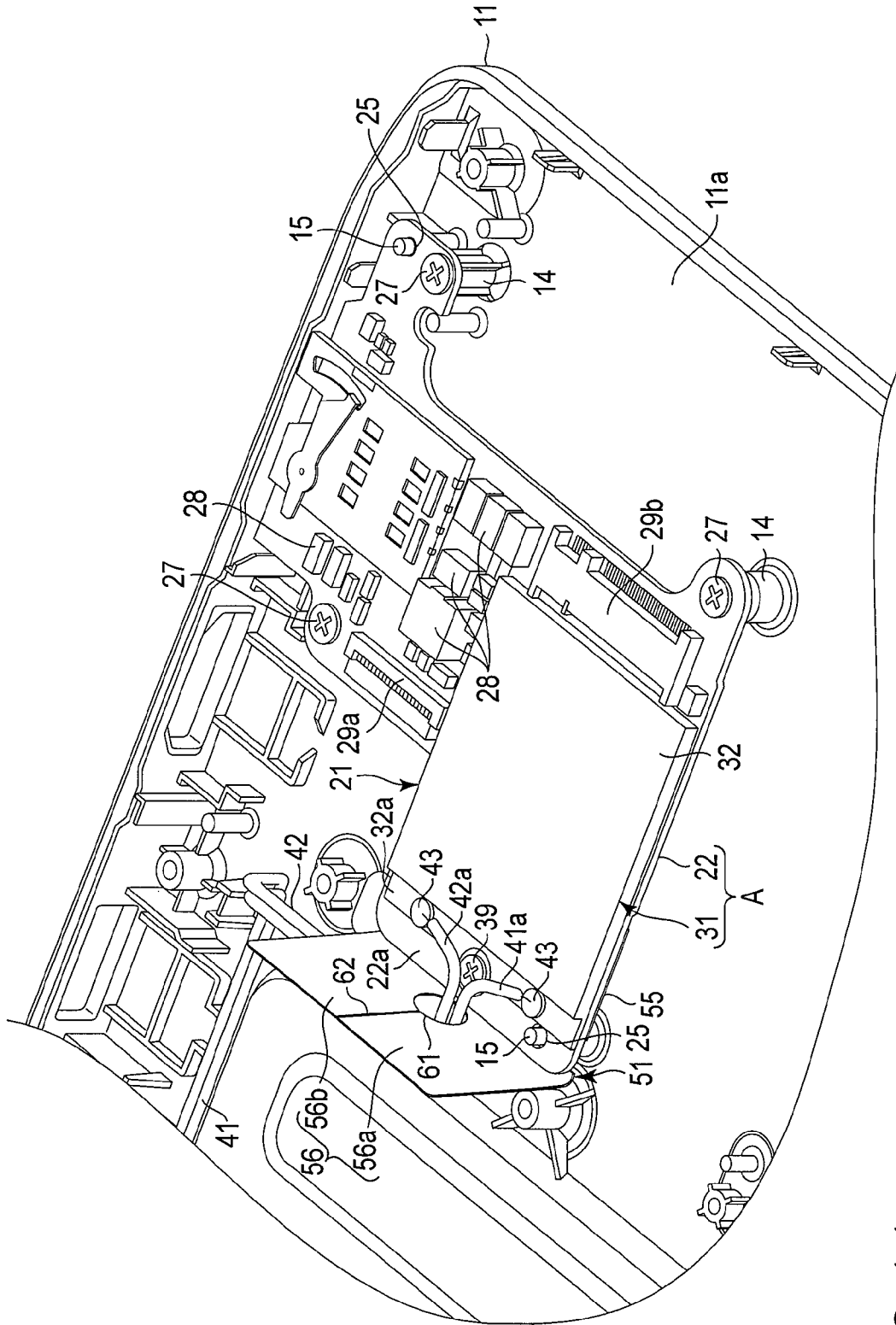


FIG. 11

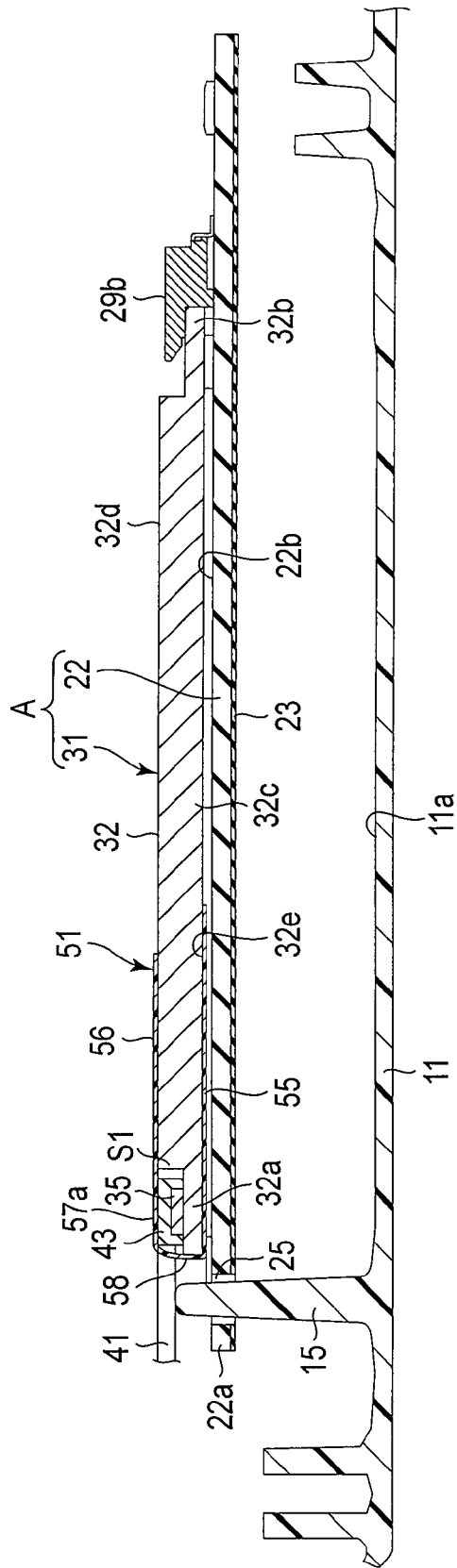


FIG. 12

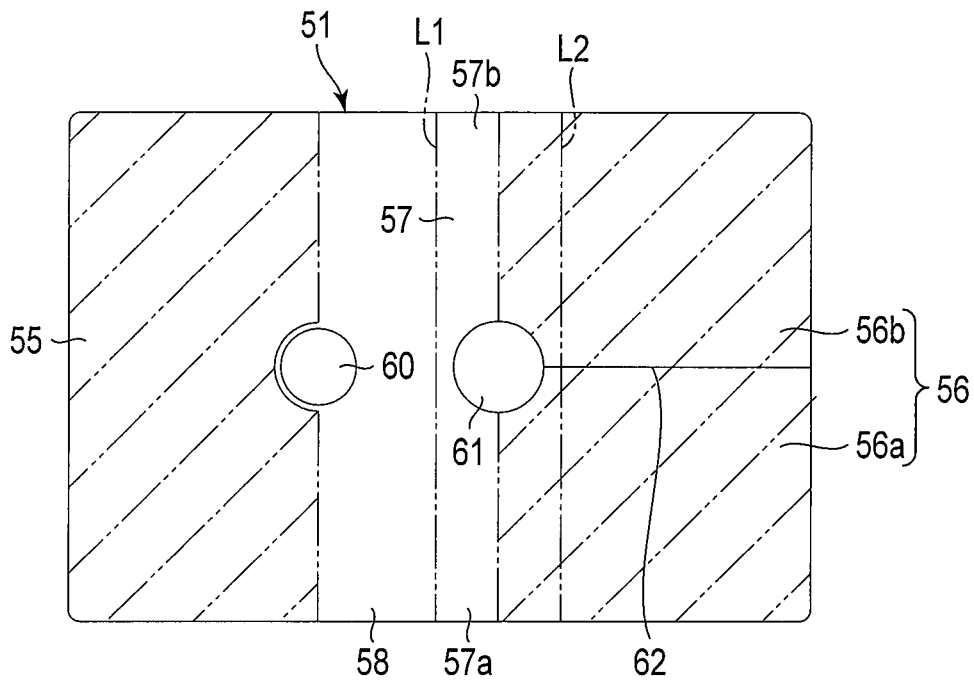


FIG. 13

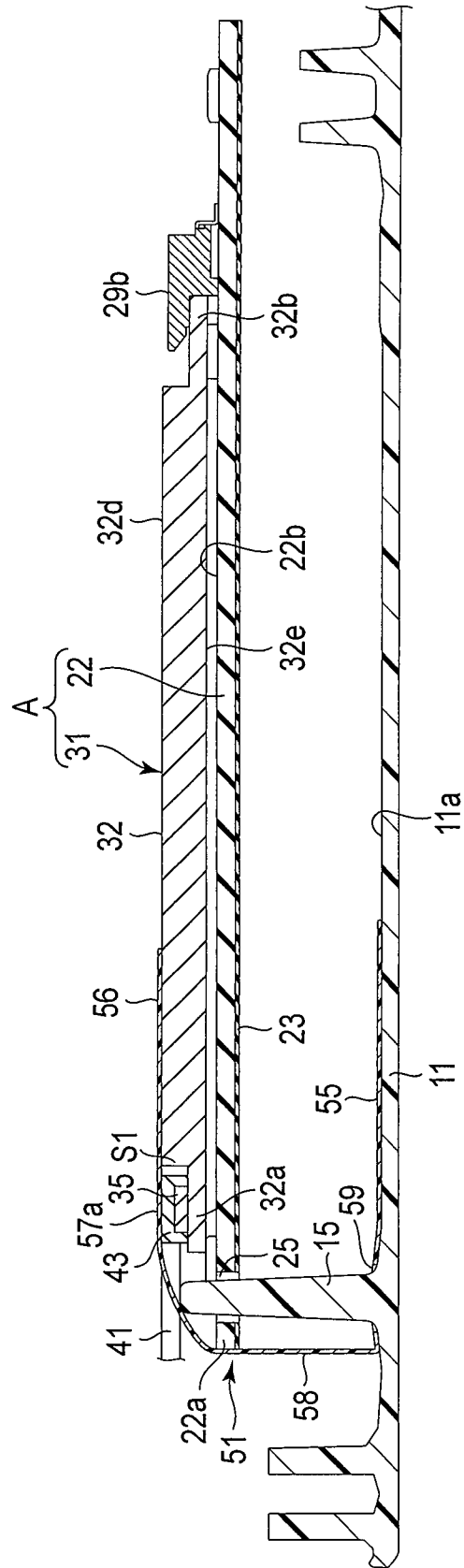


FIG. 14

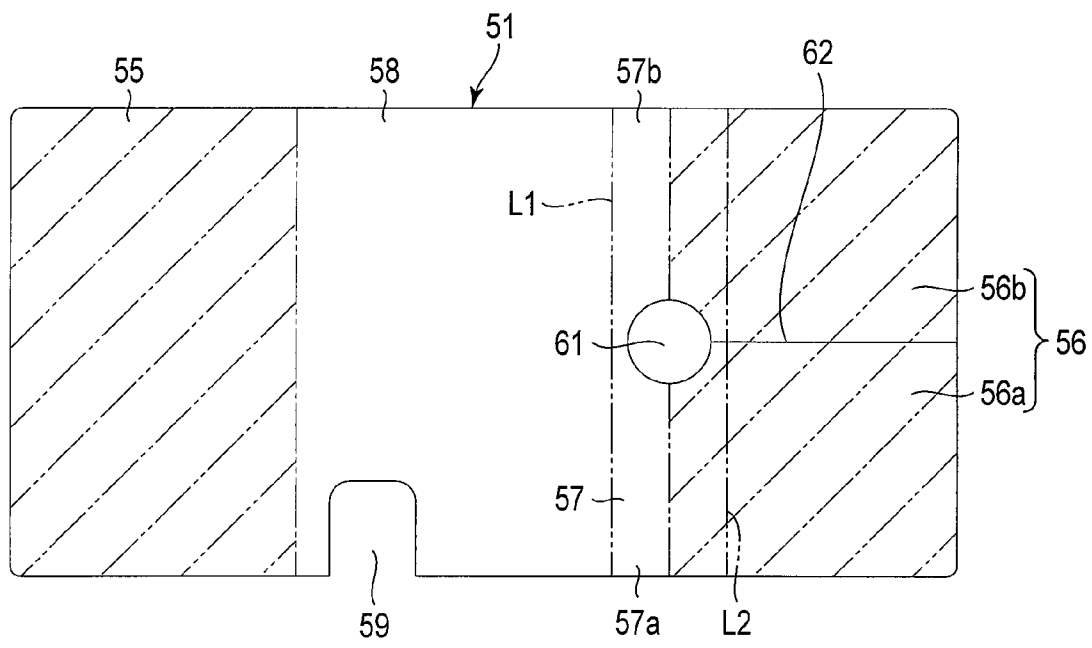


FIG. 15

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ELECTRONIC APPARATUS

CROSS-REFERENCE TO RELATED
APPLICATIONS

This application claims the benefit of U.S. Provisional Application No. 61/891,835, filed Oct. 16, 2013, the entire contents of which are incorporated herein by reference.

FIELD

Embodiments described herein relate generally to an electronic apparatus.

BACKGROUND

There is provided an electronic apparatus comprising a module for wireless communication accommodated in a housing.

It is desired that electronic apparatuses be thinner. To realize this, it is desired that a module terminal of a module and a cable terminal of a cable fitted thereto not be detached.

BRIEF DESCRIPTION OF THE DRAWINGS

A general architecture that implements the various features of the embodiments will now be described with reference to the drawings. The drawings and the associated descriptions are provided to illustrate the embodiments and not to limit the scope of the invention.

FIG. 1 is an exemplary perspective view of an electronic apparatus of a first embodiment;

FIG. 2 is an exemplary perspective view illustrating a point, viewed from the back side, where a wireless communication device of the electronic apparatus shown in FIG. 1 is arranged;

FIG. 3 is an exemplary backside view illustrating the point shown in FIG. 2;

FIG. 4 is an exemplary sectional view along line F4-F4 in FIG. 3;

FIG. 5 is an exemplary sectional view along line F5-F5 in FIG. 3;

FIG. 6 is an exemplary developed view illustrating an insulator of the wireless communication device shown in FIG. 2;

FIG. 7 is an exemplary sectional view of the insulator shown in FIG. 6;

FIG. 8 is an exemplary backside view illustrating that the insulator is attached to a printed wiring board for wireless communication shown in FIG. 6;

FIG. 9 is an exemplary perspective view illustrating a part of the wireless communication device shown in FIG. 2 and a cable terminal before the insulator is attached on a first surface of a module;

FIG. 10 is an exemplary perspective view illustrating a cable terminal of the cable of the wireless communication device shown in FIG. 2;

FIG. 11 is an exemplary perspective view illustrating a point, viewed from the back side, where the wireless communication device of the electronic apparatus shown in FIG. 1, before the insulator is attached on the first surface of the module;

FIG. 12 is an exemplary sectional view corresponding to FIG. 4, illustrating an electronic apparatus of a second embodiment;

FIG. 13 is an exemplary developed view illustrating the insulator of the electronic apparatus shown in FIG. 12;

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FIG. 14 is an exemplary sectional view corresponding to FIG. 4, illustrating an electronic apparatus of a third embodiment; and

FIG. 15 is an exemplary developed view illustrating the insulator of the electronic apparatus shown in FIG. 14.

DETAILED DESCRIPTION

Various embodiments will be described hereinafter with reference to the accompanying drawings.

In general, according to one embodiment, an electronic apparatus includes a first housing, a printed wiring board accommodated in the housing, a module arranged on the board, a plurality of cables, and a bendable sheet-shaped insulator. The module includes a module body having a first end portion protruding to form a step, and a plurality of module terminals attached to the first end portion. The first end portion is thinner than a main portion of the module body. The protrusion height of the module terminal to the first end portion is less than that of the step. The cables have cable terminals fitted to the module terminals. The insulator has a first adhesive portion adhered to an adhesive point located on the back side to the first surface opposite to the printed wiring board of the module body, a second adhesive portion adhered to the first surface, and a cover portion that is continued to the second adhesive portion and covers each cable terminal between the first and second adhesive portions.

Some components are expressed by two or more terms. Those terms are just examples. Those components may be further expressed by another or other terms. And the other components which are not expressed by two or more terms may be expressed by another or other terms.

FIGS. 1 to 11 illustrate an electronic apparatus 1 of a first embodiment. The electronic apparatus 1 is, for example, a notebook portable computer (i.e., notebook PC). It should be noted that an electronic apparatus to which the first embodiment is applicable is not limited to this example. The first embodiment is widely applicable to various types of electronic apparatuses such as a television receiver, a tablet (i.e., slate) portable computer, a cell phone (including smart phone) and a game console.

As shown in FIG. 1, the electronic apparatus 1 has a first housing 2, a second housing 3, and a pair of hinges 4a and 4b. The first housing 2 is, for example, a main housing. The first housing 2 accommodates, for example, a circuit board (not shown) as a main board.

The first housing 2 is formed into a flat box shape by combining an upper case member 11 and a lower case member 12. In the description that follows, upper, lower, left and right are defined from the point view of a user. Also, a location close to the user is defined as front, while a location distant from the user is defined as back.

The upper case member 11 extends in a longitudinal direction (for example, substantially horizontal direction) of the first housing 2. A keyboard 13 as an example of an input portion is provided on the upper case member 11. The input portion provided on the upper case member 11 may be, for example, a touch panel (i.e., touch sensor) or other input apparatus, not limited to the keyboard 13.

Also, the lower case member 12 extends in a longitudinal direction of the first housing 2. When the electronic apparatus 1 is placed on a desk, the lower case member 12 faces the desk surface (i.e., external placement surface).

The second housing 3 is a display housing, for example. The second housing 3 accommodates a display 18 (i.e., display module or unit). An example of the display 18 is a

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liquid crystal display device, not limited thereto. The display **18** has a display screen **18a** that displays an image.

The second housing **3** is formed into a flat box shape. A front wall **19** of the second housing **3** is provided with an opening **19a**, on which the display screen **18a** is exposed.

The hinges **4a** and **4b** are rotatably attached (i.e., openable and closable) to the first housing **2** and the second housing **3**. This makes the electronic apparatus **1** openable and closable (i.e., deformable or foldable). The second housing **3** is rotatable between a first state (for example, closing state) and a second state (for example, opening state) as mentioned below.

In the first state, the second housing **3** is overlapped with the first housing **2** so that the electronic apparatus **1** is closed. Specifically, the upper cover member **11** of the first housing **2** and the front wall **19** of the second housing **3** are overlapped with each other so that the display screen **18a** and the keyboard **13** are hidden from outside.

In the second state, the second housing **3** is stood by the first housing **2** so that the electronic apparatus **1** is open. Specifically, the display screen **18a** and the keyboard **13** are exposed outside.

The upper case member **11** comprises a plurality of bosses **14** with screw holes for arranging a wireless communication device **21** (described below) and a plurality of protrusions **15** for positioning. These bosses **14** and protrusions **15** are formed integrally with the upper case member **11**, protruding from an inner surface **11a** of an upper wall portion of the upper case member **11** toward the lower case member **12**.

It should be noted that FIGS. **2** and **11** are perspective views illustrating a point where the wireless communication device **21** (described below) with the lower case member **12** detached and the upper case member **11** upside down. Since FIG. **4** is a sectional view along line F4-F4 in FIG. **3**, the bosses **14** and the protrusions **15** are drawn upward in FIGS. **2**, **4** and **11**.

The electronic apparatus **1** comprises the wireless communication device **21**, which is accommodated in the first housing **2**. As shown in FIG. **2**, the wireless communication device **21** comprises a printed wiring board **22**, a module **31**, a plurality of, for example, two cables **41** and **42**, and a sheet of insulator **51** for retaining terminals.

The printed wiring board **22** is a control board for wireless communication. On the surface of the printed wiring board **22** (i.e., a component mounting surface **22b**), each type of electronic component **28** for controlling wireless communication, and connectors **29a** and **29b** are mounted around the module **31**. An insulating sheet **23** is adhered to the printed wiring board **22**. The insulating sheet **23** is a back surface of the printed wiring board **22**. This back surface is smooth.

As shown in FIG. **8**, the printed wiring board **22** has an adhesive surface **22e** as an adhesive point. The adhesive surface **22e** is a part of the smooth back surface of the portion sandwiched between a first side edge **22c** and a second side edge **22d**. The first side edge **22c** and the second side edge **22d** extend in a front-back direction, being parallel with each other.

The adhesive surface **22e** (i.e., adhesive point) is located on the back side to a surface **32d** (i.e., first surface) opposite to the printed wiring board **22** of a module body **32** (described below). The surface **32d** is parallel to the back surface of the printed wiring board **22** as an example.

As shown in FIG. **8**, the printed wiring board **22** has the same number of fitting holes **24** as the bosses **14**. The fitting holes **24** are arranged in positions corresponding to the arrangements of the plurality of bosses **14**. Further, the printed wiring board **22** has the same number of holes **25** for

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positioning as the protrusions **15**. The holes **25** are arranged in positions corresponding to the arrangements of the plurality of the protrusions **15**.

The printed wiring board **22** has a screw receiving portion, which is formed by, for example, a stud nut **26**. The stud nut **26** is fixed to the center portion in a longitudinal direction of an edge portion **22a**, close to the front, of the printed wiring board **22**. Since the stud nut **26** is not covered by the insulating sheet **23**, the stud nut **26** is attached so as to be exposed on the back surface of the printed wiring board **22**.

The printed wiring board **22** is supported by the tip of each boss **14** by directing the insulating sheet **23** to the inner surface **11a** of the upper case member **11**. This supporting state is fixed by a screw **27** passed into each of the fitting holes **24** and screwed to the bosses **14**. Under such a fixing structure, the printed wiring board **22** is arranged parallel to (i.e., substantially in a horizontal direction of) the upper wall portion of the upper case member **11**.

The module **31** is, for example, an antenna module for wireless communication in compliance with the Next Generation Form Factor (NGFF) standard. The maximum thickness of the module **31** is 3.85 mm. The module **31** comprises the module body **32** and a plurality of, for example, three module terminals **35**, **36** and **37**. The module terminal **37** may be omitted.

As shown in FIGS. **11** and **12**, the module body **32** is flat, whose plan-view configuration is laterally-long square, for example. The module body **32** comprises a first end portion **32a** (for example, front end portion) and a second end portion **32b** (for example, back end portion) located opposite to the first end portion **32a**.

Each of the back surfaces of the first end portion **32a**, the second end portion **32b**, and a main portion **32c** therebetween are continuously flush, extending in a substantially horizontal direction. The main portion **32c** has a maximum thickness. The thickness of the first end portion **32a** and the second end portion **32b** is thinner than that of the main portion **32c**.

The first end portion **32a** protrudes laterally (for example, forward) from the main portion **32c**, forming a step **S1** with the main portion **32c**. Similarly, the second end portion **32b** protrudes laterally (for example, backward) from the main portion **32c**, forming a step with the main portion **32c**. The second end portion **32b** is detachably insertion-connected to the connector **29b**.

The module terminals **35**, **36** and **37** are attached to the first end portion **32a**. The module terminals **35** and **36** are arranged to the end in a longitudinal direction of the first end portion **32a**, while the module terminal **37** is arranged in the first end portion **32a** in a position between the module terminals **35** and **36**. The module terminals **35**, **36** and **37** are electrically connected to components such as an antenna element built into the main portion **32c**.

Each of the module terminals **35**, **36** and **37** protrudes from the first end portion **32a** toward the lower case member **12**. The circumference of this protruding portion is circular. A protrusion height H_a of the module terminals **35**, **36** and **37** to the first end portion **32a** is less than H_b , a height of step **S1**. Each of the module terminals **35**, **36** and **37** has a connector hole for electrical connection that opens in the center of the tip surface of the protruding portion.

The module **31** is arranged on the printed wiring board **22**. The process of this arrangement will be explained below.

First of all, the second end portion **32b** of the module **31** is insertion-connected to the connector **29b**, by which the module **31** is overlapped with the printed wiring board **22**.

In this state, a back surface **32e** (i.e., second surface) of the module body **32** opposite to the surface **32d** (first surface) is approximated to the component mounting surface **22b** of the printed wiring board **22**. In the same state, the stud nut **26** cannot be covered up by the first end portion **32a**.

In addition, in the same state, the edge portion **22a** of the printed wiring board **22** protrudes in a protruding direction (for example, forward) of the first end portion **32a** to the main portion **32c** than the first end portion **32a** of the module body **32**. However, the edge portion **22a** does not necessarily protrude to the first end portion **32a**. For example, the tip surface of the first end portion **32a** and the tip surface extending in a longitudinal direction of the edge portion **22a** may be continued flush horizontally. Alternatively, the tip portion of the first end portion **32a** may recede to the tip surface extending in a longitudinal direction of the edge portion **22a**.

Next, a screw **39** is screwed to the stud nut **26**, by which the first end portion **32a** is pressed by the edge portion **22a** at the head of the screw **39** and the module **31** is attached. An assembly **A** is formed by the printed wiring board **22** and the module **31** thus assembled.

Cables **41** and **42** are used as antenna cable. It is preferable that the length of the cables **41** and **42** be the same so that components can be easily managed. The cables **41** and **42** have the same structure and have a cable terminal **43**, for example, at least at one end of a coaxial cable.

As shown in FIG. 10, the cable terminal **43** has a tubular portion **43a** and a connector pin **43b**. The tubular portion **43a** is cylindrical, with an insulating member (not shown) attached to its inner perimeter. The tubular portion **43a** gets connected by being fixed to any of the module terminals **35**, **36** and **37**. The connector pin **43b** is inserted into the connector holes of the module terminals **35**, **36** and **37**, by which the module terminal and the cable terminal **43** are electrically connected.

The cable terminal **43** of the cable **41** is fixed to the circumference of the module terminal **35**. The cable terminal **43** of the cable **42** is fixed to the circumference of the module terminal **36**.

As shown in FIGS. 3 and 11, end portions **41a** and **42a** of the cables **41** and **42** are wired along a longitudinal direction of the first end portion **32a** on the first end portion **32a** and approximated with each other. In addition, the cables **41** and **42** are wired to the inside of the upper case member **11** and connected to predetermined electrical components so that they are put together to contact with each other.

The insulator **51** is sheet-shaped and bendable (i.e., freely bendable). The insulator **51** is formed by providing an adhesive layer to a sheet-shaped base member **52**.

For the base member **52**, an electrical insulating material, for example, a polyethylene terephthalate (PET) sheet, can be preferably used. The base member **52** is, for example, square, i.e., substantially rectangle. It is preferable that the width of the base member **52** be almost equal to that of the adhesive surface **22e** of the printed wiring board **22**. The width of the adhesive surface **22e** is defined by the first side edge **22c** and the second side edge **22d**.

The adhesive layer is laminated on one surface of the base member **52** as illustrated in FIGS. 6 and 7. That is, a first adhesive layer **53** is laminated in a portion on the side of one end portion in a longitudinal direction of the base member **52**, while a second adhesive layer **54** is laminated in a portion on the side of the other end portion in a longitudinal direction of the base member **52**. Although the adhesive layer may be on the whole of one surface of the base member **52**, it is preferable that the first adhesive layer **53** and the

second adhesive layer **54** be separately arranged since the amount of adhesive used can be reduced.

One end portion of the base member **52** and the first adhesive layer **53** form a first adhesive portion **55** of the insulator **51**. Similarly, the other end of the base member **52** and the second adhesive layer **54** form a second adhesive portion **56** of the insulator **51**.

FIG. 6 shows each of the first adhesive layer **53** and the second adhesive layer **54** with parallel oblique lines of two-dot chain lines so that the layers can be identified easily. The second adhesive layer **54** crosses a part of a cover portion **57** (described below) in the first embodiment but also can be arranged so that it does not cross.

In the structure of the second adhesive layer **54** crossing the cover portion **57** (described below), the adhesive area of the second adhesive portion **56** is larger. Such a structure is preferable as enhancing reliability of keeping the cover portion **57** tension-applied. In a structure where the second adhesive layer **54** does not cross the cover portion **57**, the cable terminal **43** is not adhered to the cover portion **57**. Such a structure is preferable since there is no concern whether the cable terminal **43** is moved by the tension of the cover portion **57**.

The insulator **51** has the cover portion **57**, which is continued to the second adhesive portion **56** between the first adhesive portion **55** and the second adhesive portion **56**. In FIG. 6, the cover portion **57** represents a region sandwiched between two-dot chain lines **L1** and **L2**. The cover portion **57** is continued to the first adhesive portion **55** through a non-adhesive portion **58** that does not have an adhesive layer.

The insulator **51** has a passage portion **61**, into which the cables **41** and **42** are passed. The passage portion **61** is formed by, for example, a circular hole that is open to the cover portion **57**. The passage portion **61** is located in the center of a width direction of the insulator **51**.

The insulator **51** has a separating portion **62**. The separating portion **62** is made by, for example, slit. The slit (separating portion **62**) is located in the center of a width direction of the insulator **51**, extending in a longitudinal direction of the insulator **51**. One end of the slit reaches one end edge in a longitudinal direction of the insulator **51** while the other end reaches the passage portion **61**.

Therefore, the second adhesive portion **56** is separated into a first adhesive region **56a** and a second adhesive region **56b** by the slit (separating portion **62**). In addition, the cover portion **57** is separated into a first cover region **57a** and a second cover region **57b** by the passage portion **61** and the separating portion **62** that are mutually continued.

The separating portion **62** is not limited to slit. For example, it is possible that the separating portion **62** is formed by a slot having the same width as the diameter of the passage portion **61**. However, it is preferable that the separating portion **62** be slit since the adhesive areas of the first adhesive region **56a** and the second adhesive region **56b** are larger.

The insulator **51** has a gap **59** released to its side edge. The gap **59** is U-shaped, for example, and arranged to accept the protrusion **15** in a front side location.

Subsequently, a process of assembling the wireless communication device **21** will be explained.

In this case, the printed wiring board **22** and the module **31** are prepared in a state of the assembly **A**, which has been already assembled in the above-mentioned process.

First of all, the insulator **51** is attached to the assembly **A**. Specifically, the first adhesive portion **55** and a part of the non-adhesive portion **58** of the insulator **51** face the back

surface opposite to the component mounting surface **22b** of the printed wiring board **22**. In this state, the first adhesive portion **55** is adhered to the adhesive surface **22e** (i.e., adhesive point) by the first adhesive layer **53**. The adhesive surface **22e** comprises a part of the back surface of the printed wiring board **22**.

In this case, both side edges of the first adhesive portion **55** are aligned with the first side edge **22c** and the second side edge **22d** of the printed wiring board **22**. It is therefore possible to fix a position where the insulator **51** is attached in a right and left direction of the printed wiring board **22** to become adhered. Further, the tip portion of the first adhesive portion **55** is aligned with an edge **22f** of the insulator **51** perpendicularly continued to the first side edge **22c**. It is therefore possible to fix a position where the insulator **51** is attached in a back and forth direction of the printed wiring board **22** to become adhered.

FIG. **8** shows that the insulator **51** is thus adhered to the back surface of the printed wiring board **22**. In this state, a portion close to the cover portion **57** of the non-adhesive portion **58** as well as the second adhesive portion **56** and the cover portion **57** of the insulator **51** protrude from the edge portion **22a** of the printed wiring board **22**. In the same state, the gap **59** of the insulator **51** is opposed to the hole **25** of the printed wiring board **22**. In the same state, the stud nut **26** is covered by a region of the insulator **51** along the back surface of the printed wiring board **22**.

Next, the assembly A is fixed to the upper case member **11**.

First of all, each of the holes **25** of the printed wiring board **22** is fixed to each of the protrusions **15** of the upper case member **11** so that each protrusion **15** is passed into the holes **25**. The printed wiring board **22** is then supported by the tip surface of each of the bosses **14**. In this case, a screw hole of each of the bosses **14** is opposed to each of the fitting holes **24** of the printed wiring board **22**.

Next, the screw **27** is passed into each of the fitting holes **24** and screwed to the boss **14** so that the printed wiring board **22** is attached to the upper case member **11**.

In such a process, the assembly A is arranged in the upper case member **11**. In this state, the back surface of the printed wiring board **22** and the insulator **51** attached thereon are opposed to the inner surface **11a** of the upper case member **11**. Also, if the inner surface **11a** is covered by other insulators, the back surface of the printed wiring board **22** and the insulator **51** attached thereon are opposed to the other insulators. It should be noted that when the first housing **2** is assembled, the surface **32d** of the module body **32** is separated further than the back surface of the printed wiring board **22** on the basis of the inner surface **11a**, being opposed to the inner surface (not shown) of the lower case member **12**.

As mentioned above, the insulator **51** covers the stud nut **26** from the back surface of the printed wiring board **22**, by which the screw shaft tip of the screw **27** is covered by the insulator **51**. When a structure (not shown) is arranged between the inner surface **11a** of the upper case member **11** and the printed wiring board **22**, the structure is not formed by being interfered by the screw **27** with the assembly A attached to the upper case member **11**. Therefore, it is possible to protect the structure.

Next, the cables **41** and **42**, which have been already wired in a predetermined state in the upper case member **11**, are connected to the module **31**.

The cable **41** is connected by fitting the tubular portion **43a** of the cable terminal **43** to the circumference of, for example, the module terminal **35** of the module **31**. Then, the connector pin **43b** of the cable terminal **43** is inserted into

the connector hole of the module terminal **35**. The cable terminal **43** and the module terminal **35** are thus electrically connected.

Similarly, the cable **42** is connected by fitting the tubular portion **43a** of the cable terminal **43** to the circumference of, for example, the module terminal **36** of the module **31**. Then, the connector pin **43b** of the cable terminal **43** is inserted into the connector hole of the module terminal **36**. The cable terminal **43** and the module terminal **36** are thus electrically connected.

The cable terminal **43**, connected respectively to the module terminals **35** and **36** as mentioned above, is located at the same height as the surface **32d** of the module body **32** or slightly shifted from the surface **32d** to the printed wiring board **22**.

The passage portion **61** and the separating portion **62** of the insulator **51** are shifted in a longitudinal direction of the edge portion **22a** of the printed wiring board **22** to the connecting portion between the module terminal **35** and the cable terminal **43** of the cable **41** and the connecting portion between the module terminal **36** and the cable terminal **43** of the cable **42**. Specifically, the passage portion **61** and the separating portion **62** are located between both connecting portions, more preferably, shifted from both connecting portions by the same distance.

Subsequently, each cable terminal **43** is retained by the insulator **51** in the following process so that the cable terminal **43** is not detached from the module terminals **35** and **36**.

First of all, the end portion **41a** of the cable **41** and the end portion **42a** of the cable **42** are wired along a longitudinal direction of the edge portion **22a** (i.e., direction of the step **S1** extending). The end portions **41a** and **42a** are then approximated to correspond with each other.

Next, the cables **41** and **42** are put together by being bent at an angle substantially perpendicular to the end portions **41a** and **42a**. Subsequently, the cables **41** and **42**, which have been put together, are passed into the passage portion **61** of the insulator **51**.

In this case, as shown in FIG. **9**, the second adhesive portion **56** of the insulator **51** is bent upward to open the separating portion **62**. By way of the separating portion **62**, the intermediate portions of the cables **41** and **42** are guided to the passage portion **61**. It is therefore easy to pass the cables **41** and **42** into the passage portion **61** without passing the cables **41** and **42** into the passage portion **61** from the end.

Further, the separating portion **62** is closed after the cables **41** and **42** are guided to the passage portion **61**, since the separating portion **62** is slit. Therefore, the cables **41** and **42**, which are passed into the passage portion **61**, are less likely to be detached by way of the separating portion **62**. FIG. **11** shows that the cables **41** and **42** are passed into the passage portion **61** of the insulator **51**.

Lastly, the second adhesive portion **56** of the insulator **51** is adhered to the surface **32d** of the module body **32** while the insulator **51** is dragged. The insulator **51** is then arranged over the surface **32d** of the module body **32** from the back surface of the printed wiring board **22**, rolling the edge portion **22a** of the printed wiring board **22** and the first end portion **32a** of the module body **32**.

The second adhesive portion **56** is separated into two sections by the separating portion **62**. Therefore, the first adhesive region **56a** and the second adhesive region **56b** are separately connected to the surface **32d** of the module body **32**.

By adhering the first adhesive region **56a** to the surface **32d**, the first cover region **57a** of the cover portion **57** of the insulator **51** remains tension-applied. The first cover region **57a** protrudes over the edge portion **22a** of the printed wiring board **22** and the surface **32d** of the module body **32**. The cable terminal **43** of the cable **41** and the end portion **41a** of the cable **41** continued to the terminal are covered by the first cover region **57a**.

Similarly, by adhering the second adhesive region **56b** to the surface **32d**, the second cover region **57b** of the cover portion **57** of the insulator **51** remains tension-applied. The second cover region **57b** protrudes over the edge portion **22a** of the printed wiring board **22** and the surface **32d** of the module body **32**. The cable terminal **43** of the cable **42** and the end portion **42a** of the cable **42** continued to the terminal are covered by the second cover region **57b**.

By the insulator **51** arranged as mentioned above, the cable terminals **43** remains fixed to the module terminals **35** and **36**.

In this state, the first cover region **57a** of the insulator **51** and the cable terminal **43** fixed to the module terminal **35** are contacted, or approximated with a slight gap. Similarly, the second cover region **57b** of the insulator **51** and the cable terminal **43** fixed to the module terminal **36** are contacted, or approximated with a slight gap. When there is a gap (separation distance) between the cable terminals **43** and the cover portion **57**, the separation distance is shorter than the fixing depth of the cable terminals **43** to the module terminals **35** and **36**.

It is preferable that the first cover region **57a** and the second cover region **57b** be kept tension-applied since the arrangement of the first cover region **57a** and the second cover region **57b** to the cable terminals **43** covered by these cover regions is properly maintained. The phrase "arrangement of . . . properly maintained" means that the cover portion **57** is arranged so that the cable terminals **43** are not detached.

FIG. 2 shows that the wireless communication device **21** is installed into the upper case member **11** in the above-mentioned process. As shown in FIG. 2, the cables **41** and **42** are passed into the passage portion **61** in a location shifted in a longitudinal direction of the end portion **22a**. In such a wiring structure, a region bent from the end portion **41a** of the cable **41** and a region bent from the end portion **42a** of the cable **42** contact the edge of a hole of the passage portion **61**. The cables **41** and **42** dragged from the passage portion **61** are wired along a predetermined path in the upper case member **11**.

The electronic apparatus **1** in the above-mentioned structure, being thin, comprises the wireless communication device **21**, which is thin in conformance with the NGFF standard. Since the wireless communication device **21** is thinner, the protrusion height H_a of the module terminals **35**, **36** and **37** are low (i.e., the module terminals **35**, **36** and **37** are short). This makes the fixing depth of the cable terminals **43** to the module terminals **35** and **36** shallow.

Therefore, when the cables **41** and **42** are not properly wired to the module **31**, it is more likely that the cable terminals **43** are detached from the module terminals **35** and **36**.

The electronic apparatus **1** of the first embodiment comprises the insulator **51** to keep the cable terminals **43** fixed to the module terminals **35** and **36**.

As mentioned above, the insulator **51** is arranged over the surface **32d** of the module body **32** from the back surface of the printed wiring board **22**, rolling the edge portion **22a** of the printed wiring board **22** and the first end portion **32a** of

the module body **32**. The cover portion **57** of the insulator **51** covers the cable terminals **43** in a tension-applied state.

Therefore, when the cable terminals **43** are likely to be detached from the module terminals **35** and **36**, the cable terminals **43** can be retained so as not to be detached by the cover portion **57**.

In this case, when the cable terminals **43** contacts the cover portion **57**, the cover portion **57** works as a stopper to prevent the cable terminals **43** from moving in a direction of being detached from the module terminals **35** and **36**.

Also, when the cable terminals **43** and the cover portion **57** are approximated with a separation distance, first of all, the terminals **43** are moved in a direction of being detached from the module terminals **35** and **36** by a distance in which the separation distance is eliminated. However, the cover portion **57** works as a stopper immediately thereafter. The cable terminals **43** remains fixed to the module terminals **35** and **36**.

Further, in the first embodiment, the cover portion **57** covers the end portions **41a** and **42a** of the cables **41** and **42** in addition to the cable terminals **43**. The cables **41** and **42** contact or are able to contact the edge of the passage portion **61**.

Therefore, although the cables **41** and **42** are moved by wiring the cables **41** and **42** into the upper case member **11**, the contact between the cover portion **57** and the cables **41** and **42** prevents this motion from spreading to the end portions **41a** and **42a**. The cable terminals **43** are then less likely to receive a force in a direction of being detached from the module terminals **35** and **36** and to be detached from the module terminals **35** and **36**.

In addition, in the first embodiment, as mentioned above, the end portions **41a** and **42a** are kept wired in a longitudinal direction of the edge portion **22a** of the printed wiring board **22** by the cover portion **57** of the insulator **51** that covers the end portions **41a** and **42a**. Also, the cables **41** and **42** are passed into the passage portion **61** of the insulator **51** in a direction orthogonal to the fixing direction of the cable terminals **43** to the module terminals **35** and **36** and in a direction of being separated from the module body **32**.

The end portions **41a** and **42a** of the cables **41** and **42** are then kept properly wired. Therefore, the cable terminals **43** are less likely to receive a force in a direction of being detached from the module terminals **35** and **36** to maintain not so that the cable terminals **43** are not detached.

Although the module **31**, which is thin, is appropriate for contributing to making the electronic apparatus **1** thinner, the module **31** and the cables **41** and **42** are less likely to be disconnected. Therefore, it is possible that efficiency of assembly by retrying the connection at the time of production is not reduced. Also, it is possible to improve the quality of the electronic apparatus **1** while the connection reliability after production is secured.

As mentioned above, the insulator **51** keeps the end portions **41a** and **42a** of the cables **41** and **42** wired along the module **31** and prevents the cable terminals **43** fixed to the module terminals **35** and **36** from being detached. The insulator **51** is formed by arranging an adhesive layer (for example, the first adhesive layer **53** and the second adhesive layer **54**) to the base member **52**, which is bendable, thin and sheet-shaped. Therefore, since the thickness of the wireless communication device **21** does not increase greatly even by using the insulator **51**, the insulator does not prevent the electronic apparatus **1** from becoming thinner.

FIGS. 12 and 13 show a second embodiment. The second embodiment is the same as the first embodiment other than the matters described below. Therefore, in the second

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embodiment, the same structure as the first embodiment and the structure having the similar function are given the same reference number as the first embodiment to omit the explanation. Also, the same effect as the first embodiment is not explained. Further, in the following explanation, regarding the structures that are not shown in FIGS. 12 and 13, each figure of the first embodiment is referred to.

In the second embodiment, the structure of the insulator 51 for retaining terminals and the adhesive point, to which the first adhesive portion 55 is attached, are different from those of the first embodiment.

As shown in FIG. 13, the insulator comprises a screw passing hole 60. The screw passing hole 60 is arranged to span the first adhesive portion 55 and the non-adhesive portion 58.

As shown in FIG. 12, the back surface 32e (second surface) of the first end portion 32a of the module 31 is used as an adhesive point.

Next, a process of assembling the wireless communication device 21 in the second embodiment will be explained.

First of all, the first adhesive portion 55 of the insulator 51 is adhered to the back surface of the printed wiring board 22. A part of the non-adhesive portion 58 of the insulator 51, the cover portion 57 and the second adhesive portion 56 protrude from the edge portion 22a of the printed wiring board 22.

Next, the second end portion 32b of the module 31 is inserted and connected to the connector 29b so that the module 31 is overlapped with the printed wiring board 22. In this state, the screw passing hole 60 of the insulator 51 is opposed to the stud nut 26 (FIG. 5).

Subsequently, the screw 39 (FIG. 5) is screwed to the stud nut 26 from the front side of the printed wiring board 22. Then, the first end portion 32a is pressed to the printed wiring board 22 in the head of the screw 39, and the module 31 is attached. The assembly A is thus assembled.

In this state, connection is made by fixing the cable terminals 43 to the module terminals 35 and 36 (FIG. 9) of the module 31. After that, the cables 41 and 42 are passed into the passage portion 61 of the insulator 51. These operations are as explained in the first embodiment.

Thereafter, the second adhesive portion 56 of the insulator 51 is adhered to the surface 32d of the module body 32 while the insulator 51 is dragged. This operation is as explained in the first embodiment.

The insulator 51 is then arranged over the surface (first surface) 32d of the module body 32 from the back surface (second surface) 32e of the module body 32, rolling the first end portion 32a of the module body 32.

In this case, by adhering the first adhesive region 56a of the second adhesive portion 56 to the surface 32d, the first cover region 57a of the cover portion 57 remains tension-applied. The cable terminal 43 of the cable 41 (FIG. 3) and the end portion 41a (FIG. 3) of the cable 41 are covered by the first cover region 57a.

Similarly, by adhering the second adhesive region 56b of the second adhesive portion 56 to the surface 32d, the second cover region 57b of the cover portion 57 remains tension-applied. The cable terminal 43 of the cable 42 (FIG. 3) and the end portion 42a (FIG. 3) of the cable 42 are covered by the second cover region 57b.

The insulator 51 arranged as mentioned above keeps the end portions 41a and 42a of the cables 41 and 42 wired along the module 31 and prevents the cable terminals 43 fixed to the module terminals 35 and 36 from being detached.

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The structures other than explained above are the same as the structures of the electronic apparatus 1 of the first embodiment including the structures that are not shown in FIGS. 12 and 13. Therefore, according to the structure of the electronic apparatus 1 of the second embodiment, the module 31 and the cables 41 and 42 are less likely to be disconnected for the reason given in the first embodiment, although there is the module 31, which is thin and appropriate for contributing to making the electronic apparatus 1 thinner. Also, since the insulator 51 is sheet-shaped, the thickness of the wireless communication device 21 does not greatly increase due to the use of the insulator 51. This allows the electronic apparatus 1 to be thinner.

FIGS. 14 and 15 show a third embodiment. The third embodiment is the same as the first embodiment other than the matters described below. Therefore, in the third embodiment, the same structure as the first embodiment and the structure having the similar function are given the same reference number as the first embodiment to omit the explanation. Also, the same effect as the first embodiment is not explained. Further, in the following explanation, regarding the structures that are not shown in FIGS. 14 and 15, each figure of the first embodiment is referred to.

The third embodiment differs from the first embodiment in the structure of the insulator 51 for retaining terminals and the adhesive point, to which the first adhesive portion 55 is attached.

As shown in FIG. 14, the inner surface 11a of the upper case member 11 is used as an adhesive point.

Therefore, the non-adhesive portion 58 of the insulator 51 is longer than the non-adhesive portion 58 explained in the first embodiment. Also, the first adhesive layer 53 of the first adhesive portion 55 of the insulator 51 is laminated on the surface opposite to one surface of the base member 54 (FIG. 7), on which the second adhesive layer 54 is laminated.

In FIG. 14, the first adhesive portion 55 may be adhered to the inner surface 11a of the upper case member 11 on the left of the non-adhesive portion 58, instead of the right thereof. In this case, the first adhesive layer 53 and the second adhesive layer 54 are laminated on one surface of the base member 52 (FIG. 7).

Next, a process of assembling the wireless communication device 21 in the third embodiment will be explained.

First of all, the first adhesive portion 55 of the insulator 51 is adhered to the inner surface 11a of the upper case member 11.

Next, the assembly A, which has been prepared in advance, is screwed to the upper case member 11. This process is as explained above in the first embodiment.

Thereafter, the cable terminals 43 of the cables 41 and 42 (FIG. 3) are fixed and connected to the module terminals 35 and 36 (FIG. 9) of the module 31. After that, the cables 41 and 42 are passed into the passage portion 61 of the insulator 51, which is explained as above in the first embodiment.

Lastly, the second adhesive portion 56 of the insulator 51 is adhered to the surface 32d of the module body 32 while dragging the insulator 51, which is explained as above in the first embodiment.

The insulator 51 is then arranged over the surface 32d of the module body 32 from the inner surface 11a of the upper case member 11.

In this case, by adhering the first adhesive region 56a of the second adhesive portion 56 to the surface 32d, the first cover region 57a of the cover portion 57 remains tension-applied over the end portion 22a of the printed wiring board 22 and the surface 32d of the module 31. The cable terminal

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43 of the cable 41 (FIG. 3) and the end portion 41a (FIG. 3) of the cable 41 are covered by the first cover region 57a.

Similarly, by adhering the second adhesive region 56b of the second adhesive portion 56 to the surface 32d, the second cover region 57b of the cover portion 57 remains tension-applied over the end portion 22a of the printed wiring board 22 and the surface 32d of the module 31. The cable terminal 43 of the cable 42 (FIG. 3) and the end portion 42a (FIG. 3) of the cable 42 are covered by the second cover region 57b.

The insulator 51 arranged as mentioned above keeps the end portions 41a and 42a of the cables 41 and 42 wired along the module 31 and prevents the cable terminals 43 fixed to the module terminals 35 and 36 from being detached.

The structures other than explained above are the same as the structures of the electronic apparatus 1 of the first embodiment including the structures that are not shown in FIGS. 14 and 15. Therefore, according to the structure of the electronic apparatus 1 of the third embodiment, the module 31 and the cables 41 and 42 are less likely to be disconnected for the reason given in the first embodiment, although the module 31, which is thin and appropriate for contributing to making the electronic apparatus 1 thinner. Also, since the insulator 51 is sheet-shaped, the thickness of the wireless communication device 21 does not greatly increase due to the use of the insulator 51. This allows the electronic apparatus 1 to be thinner.

While certain embodiments have been described, these embodiments have been presented by way of example only, and are not intended to limit the scope of the inventions. Indeed, the novel embodiments described herein may be embodied in a variety of other forms; furthermore, various omissions, substitutions and changes in the form of the embodiments described herein may be made without departing from the spirit of the inventions. The accompanying claims and their equivalents are intended to cover such forms or modifications as would fall within the scope and spirit of the inventions.

What is claimed is:

1. An electronic apparatus comprising:

a first housing;

a printed wiring board accommodated in the first housing;

a module arranged on the printed wiring board, the module comprising a module body having a first end portion protruding to form a step and a plurality of module terminals attached to the first end portion, the first end portion being thinner than a main portion of the module body, a protrusion height of the module terminal to the first end portion being less than a height of the step;

a plurality of cables having cable terminals fixed to the module terminals; and

a bendable sheet-shaped insulator having a first adhesive portion, a second adhesive portion and a cover portion, the first adhesive portion adhered to an adhesive point located on a back side to a first surface opposite to the printed wiring board of the module body, the second adhesive portion adhered to the first surface, the cover portion continued to the second adhesive portion and covering each of the cable terminals between the first adhesive portion and the second adhesive portion.

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2. The electronic apparatus of claim 1, wherein the cover portion is tension-applied.

3. The electronic apparatus of claim 1, wherein end portions of the cables wired so as to extend in a longitudinal direction of the first end portion on the first end portion is covered by the cover portion.

4. The electronic apparatus of claim 3, wherein the insulator has a passage portion shifted in a longitudinal direction of the first end portion to a connection portion between the module terminal and the cable terminal, and wherein the cables are passed into the passage portion.

5. The electronic apparatus of claim 4, wherein two of the cables are used, wherein the passage portion is provided between a connection portion of the cable terminal of one of the cables and the module terminal, to which the cable terminal is fixed, and a connection portion of the cable terminal of the other cable and the module terminal, to which the cable terminal is fixed, and wherein the two cables are passed into the passage portion.

6. The electronic apparatus of claim 5, wherein the insulator has a separating portion reaching the passage portion, the separating portion separating the second adhesive portion into a first adhesive region and a second adhesive region, and wherein the cover portion is separated into the first cover portion and the second cover portion by the passage portion and the separating portion, the first cover region covering the cable terminal of one of the cables and the end portion continued thereto, the second cover region covering the cable terminal of the other cable and the end portion continued thereto.

7. The electronic apparatus of claim 6, wherein the separating portion is slit.

8. The electronic apparatus of claim 1, wherein the adhesive point is a back surface of the printed wiring board, and wherein the insulator arranged over the first surface from the back surface of the printed wiring board, rolling the printed wiring board and the module.

9. The electronic apparatus of claim 8, wherein the printed wiring board has an edge portion protruding from the first end portion in a protruding direction of the first end portion, and wherein the cover portion protrudes over the edge portion and the first surface.

10. The electronic apparatus of claim 8, wherein the printed wiring board has a screw receiving portion, and wherein the module is fixed to the printed wiring board with a screw screwed to the screw receiving portion, which is covered by the insulator from a back side of the printed wiring board.

11. The electronic apparatus of claim 1, wherein the adhesive point is a second surface of the module body opposite to the first surface, and wherein the insulator arranged over from the second surface of the module body to the first surface, rolling the first end portion.

12. The electronic apparatus of claim 1, wherein the adhesive point is an inner face of the first housing.

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13. The electronic apparatus of claim 1, further comprising a wireless communication device comprising the printed wiring board and the module.

14. The electronic apparatus of claim 1, wherein the module conforms with the NGFF standard. 5

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